

# Low Loss IGBT in TrenchStop<sup>®</sup> and Fieldstop technology

- Short circuit withstand time 10μs
- Designed for :
  - Frequency Converters
  - Uninterrupted Power Supply
- TrenchStop<sup>®</sup> and Fieldstop technology for 1200 V applications offers :
  - very tight parameter distribution
  - high ruggedness, temperature stable behavior
- NPT technology offers easy parallel switching capability due to positive temperature coefficient in V<sub>CE(sat)</sub>
- Low EMI
- Low Gate Charge
- Qualified according to JEDEC<sup>1</sup> for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models : <u>http://www.infineon.com/igbt/</u>

Туре	V <sub>CE</sub>	<i>I</i> c	V <sub>CE(sat), Tj=25°C</sub>	<b>T</b> <sub>j,max</sub>	Marking	Package
IGW25T120	1200V	25A	1.7V	150°C	G25T120	PG-TO-247-3

### Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V <sub>CE</sub>	1200	V
DC collector current	I <sub>C</sub>		А
$T_{\rm C} = 25^{\circ}{\rm C}$		50	
$T_{\rm C}$ = 100°C		25	
Pulsed collector current, $t_p$ limited by $T_{jmax}$	I <sub>Cpuls</sub>	75	
Turn off safe operating area	-	75	
$V_{CE} \leq 1200V, \ T_j \leq 150^{\circ}C$			
Gate-emitter voltage	V <sub>GE</sub>	±20	V
Short circuit withstand time <sup>2)</sup>	t <sub>sc</sub>	10	μS
$V_{\text{GE}}$ = 15V, $V_{\text{CC}} \le$ 1200V, $T_{j} \le$ 150°C			
Power dissipation	P <sub>tot</sub>	190	W
$T_{\rm C} = 25^{\circ}{\rm C}$			
Operating junction temperature	Tj	-40+150	°C
Storage temperature	T <sub>stg</sub>	-55+150	
Soldering temperature, 1.6mm (0.063 in.) from case for 10s	-	260	

<sup>1</sup> J-STD-020 and JESD-022

<sup>&</sup>lt;sup>2)</sup> Allowed number of short circuits: <1000; time between short circuits: >1s.









### **Thermal Resistance**

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic	· · ·			
IGBT thermal resistance,	R <sub>thJC</sub>		0.65	K/W
junction – case				
Thermal resistance,	R <sub>thJA</sub>		40	
junction – ambient				

# **Electrical Characteristic,** at $T_j$ = 25 °C, unless otherwise specified

Deveryoter	Symphol	Conditions		Unit		
Parameter	Symbol	Conditions	min.	typ.	max.	
Static Characteristic						
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{GE}$ =0V, $I_{C}$ =500 $\mu$ A	1200	-	-	V
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$V_{\rm GE}$ = 15V, $I_{\rm C}$ =25A				
		<i>T</i> <sub>j</sub> =25°C	-	1.7	2.2	
		<i>T</i> <sub>j</sub> =125°C	-	2.0	-	
		<i>T</i> <sub>j</sub> =150°C	-	2.2	-	
Gate-emitter threshold voltage	$V_{\rm GE(th)}$	I <sub>C</sub> =1mA, V <sub>CE</sub> =V <sub>GE</sub>	5.0	5.8	6.5	
Zero gate voltage collector current	I <sub>CES</sub>	V <sub>CE</sub> =1200V, V <sub>GE</sub> =0V				mA
		<i>T</i> <sub>j</sub> =25°C	-	-	0.25	
		<i>T</i> <sub>j</sub> =150°C	-	-	2.5	
Gate-emitter leakage current	I <sub>GES</sub>	$V_{CE} = 0V, V_{GE} = 20V$	-	-	600	nA
Transconductance	${m g}_{\sf fs}$	$V_{\rm CE}$ =20V, $I_{\rm C}$ =25A	-	16	-	S
Integrated gate resistor	R <sub>Gint</sub>			8		Ω

## Dynamic Characteristic

Input capacitance	Ciss	V <sub>CE</sub> =25V,	-	1860	-	pF
Output capacitance	Coss	V <sub>GE</sub> =0V,	-	96	-	
Reverse transfer capacitance	Crss	f=1MHz	-	82	-	
Gate charge	Q <sub>Gate</sub>	$V_{\rm CC}$ =960V, $I_{\rm C}$ =25A	-	155	-	nC
		V <sub>GE</sub> =15V				
Internal emitter inductance	L <sub>E</sub>		-	13	-	nH
measured 5mm (0.197 in.) from case						
Short circuit collector current <sup>1)</sup>	I <sub>C(SC)</sub>	$V_{GE}$ =15V, $t_{SC}$ ≤10µs $V_{CC}$ = 600V, $T_{j}$ = 25°C	-	150	-	A

 $^{1)}$  Allowed number of short circuits: <1000; time between short circuits: >1s.



### Switching Characteristic, Inductive Load, at Ti=25 °C

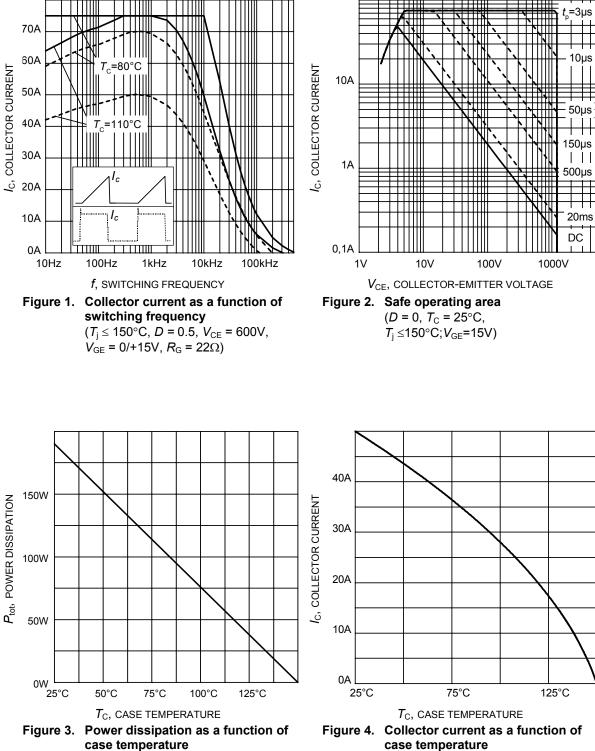
Parameter	Symbol	Conditions	Value			Unit
r ai ailletei	Symbol		min.	typ.	max.	Unit
IGBT Characteristic						
Turn-on delay time	t <sub>d(on)</sub>	<i>T</i> <sub>j</sub> =25°C,	-	50	-	ns
Rise time	t <sub>r</sub>	$V_{CC} = 600V, I_C = 25A$ $V_{GE} = -15/15V,$ $R_G = 22\Omega,$ $L_{\sigma}^{(2)} = 180nH,$ $C_{\sigma}^{(2)} = 39pF$ Energy losses include "tail" and diode reverse recovery.	-	30	-	
Turn-off delay time	$t_{d(off)}$		-	560	-	
Fall time	t <sub>f</sub>		-	70	-	
Turn-on energy	Eon		-	2.0	-	mJ
Turn-off energy	E <sub>off</sub>		-	2.2	-	1
Total switching energy	Ets		-	4.2	-	1

# Switching Characteristic, Inductive Load, at $T_j$ =150 °C

Parameter	Symbol	Conditions	Value			Unit
Falameter			min.	typ.	max.	
IGBT Characteristic						
Turn-on delay time	$t_{d(on)}$	<i>T</i> <sub>j</sub> =150°C	-	50	-	ns
Rise time	t <sub>r</sub>	$V_{CC} = 600V, I_C = 25A,$ $V_{GE} = -15/15V,$ $R_G = 22\Omega,$ $L_{\sigma}^{(2)} = 180nH,$ $C_{\sigma}^{(2)} = 39pF$ Energy losses include "tail" and diode reverse recovery.	-	32	-	
Turn-off delay time	$t_{d(off)}$		-	660	-	
Fall time	t <sub>f</sub>		-	130	-	
Turn-on energy	Eon		-	3.0	-	mJ
Turn-off energy	E <sub>off</sub>		-	4.0	-	
Total switching energy	E <sub>ts</sub>		-	7.0	-	

 $^{2)}$  Leakage inductance  $L_{\sigma}$  and Stray capacity  $C_{\sigma}$  due to dynamic test circuit in Figure E.



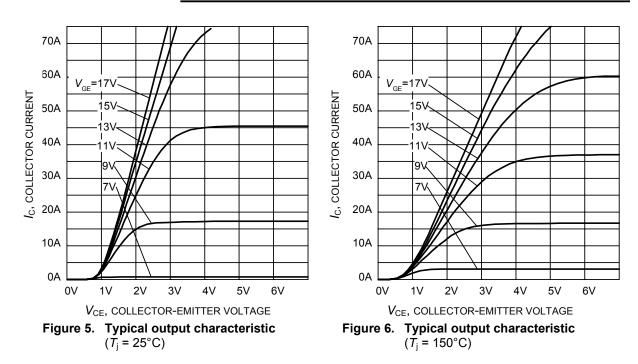


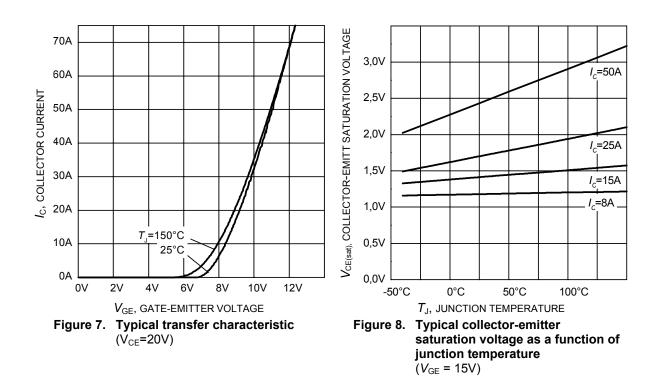
case temperature  $(T_i \le 150^{\circ}C)$ 

 $(V_{\text{GE}} \ge 15\text{V}, T_{j} \le 150^{\circ}\text{C})$ 

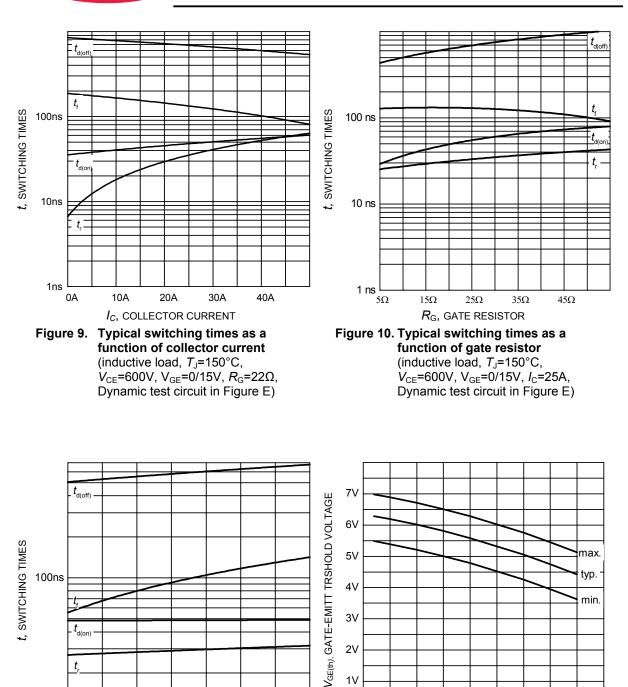


TrenchStop<sup>®</sup> Series









10ns

0°C

50°C

Figure 11. Typical switching times as a

 $T_{\rm J}$ , JUNCTION TEMPERATURE

(inductive load, V<sub>CE</sub>=600V,

V<sub>GE</sub>=0/15V, I<sub>C</sub>=25A, R<sub>G</sub>=22Ω, Dynamic test circuit in Figure E)

100°C

function of junction temperature

150°C

1V

0V

-50°C

0°C

 $(I_{\rm C} = 1.0 {\rm mA})$ 

50°C

 $T_{\rm J}$ , JUNCTION TEMPERATURE

a function of junction temperature

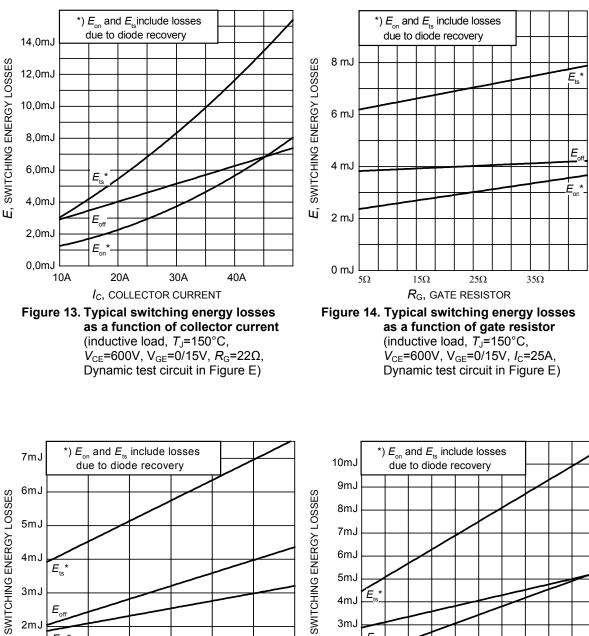
Figure 12. Gate-emitter threshold voltage as

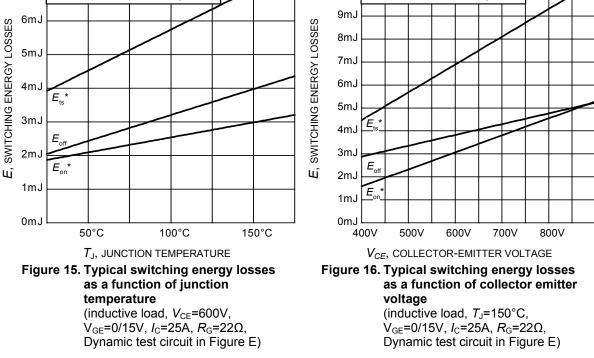
100°C

150°C

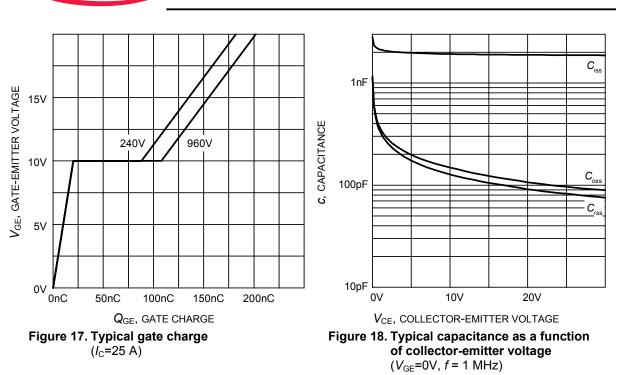


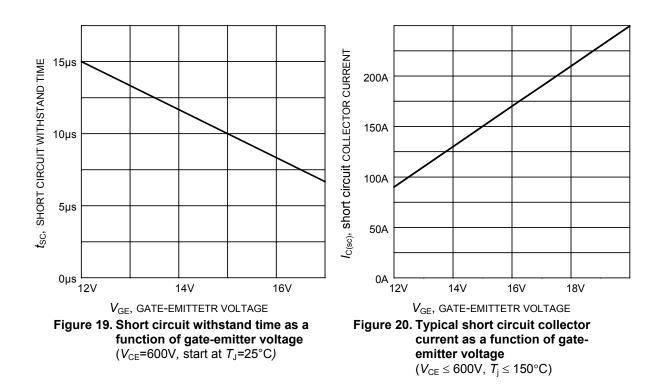
TrenchStop<sup>®</sup> Series



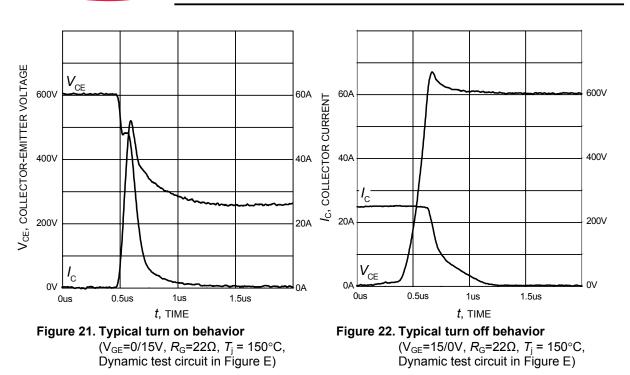


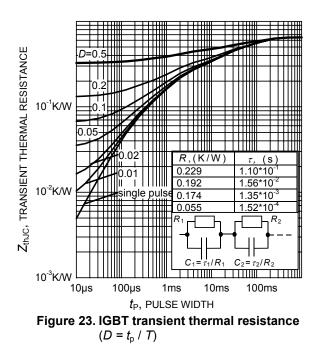




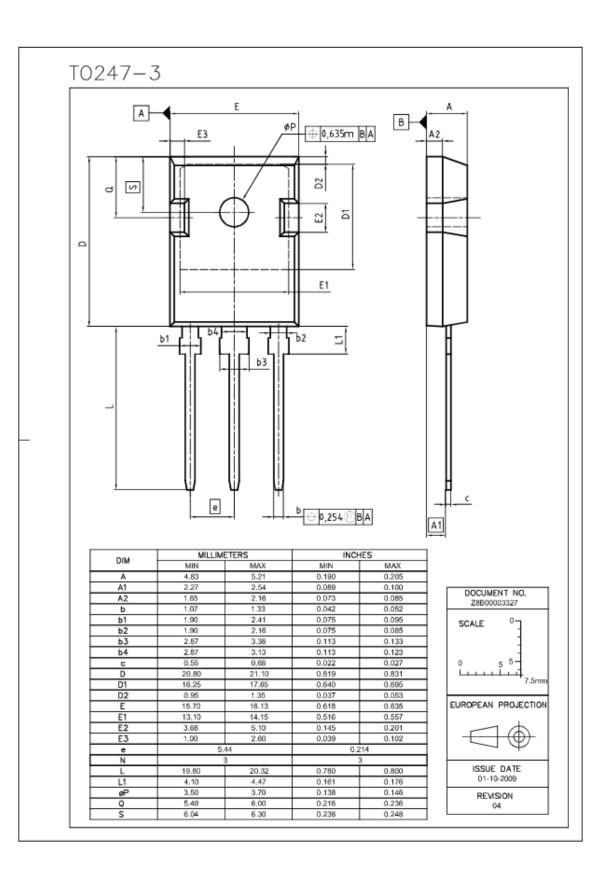


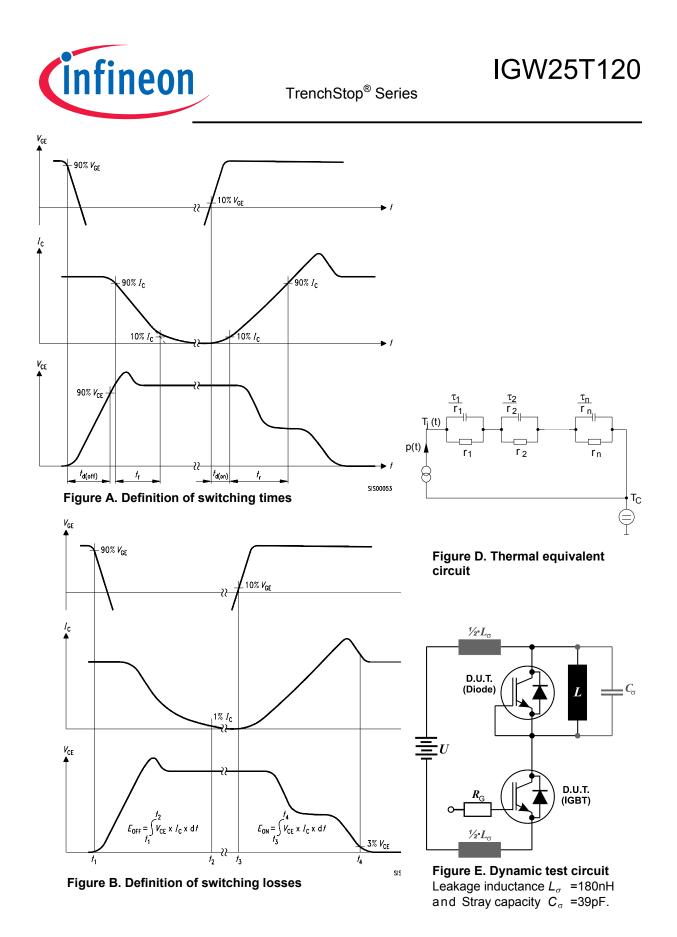














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